

Ceramic, High Q, Microwave (CBR), 0.8 pF, +/-0.25 pF, 50 V, 0402, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I



Dimensions

L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
T	0.5mm +/-0.05mm
B	0.25mm +0.05/-0.1mm

Packaging Specifications

Packaging:	T&R, 180mm, Plastic Tape
Packaging Quantity:	10000

General Information

Style:	SMD Chip
Series:	Microwave (CBR)
Chip Size:	0402
Description:	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features:	Ultra High Q, Low ESR, Class I
RoHS:	Yes
Termination:	Tin
Marking:	No
Miscellaneous:	Minimum Q = 816
Notes:	Solder Reflow Only

Specifications

Capacitance:	0.8 pF
Capacitance Tolerance:	+/-0.25 pF
Voltage DC:	50 VDC
Dielectric Withstanding Voltage:	125 V
Temperature Range:	-55/+125C
Temperature Coefficient:	COG
Dissipation Factor:	0.24%
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	10 GOhms
Quality Factor:	816

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.